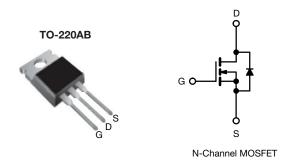
SiHP22N60EF



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Vishay Siliconix

EF Series Power MOSFET With Fast Body Diode



PRODUCT SUMMARY					
V _{DS} (V) at T _J max.	650				
R _{DS(on)} typ. (Ω) at 25 °C	$V_{GS} = 10 V$	0.158			
Q _g max. (nC)	96				
Q _{gs} (nC)	9				
Q _{gd} (nC)	21				
Configuration	Single				

FEATURES

- Low figure-of-merit (FOM) Ron x Qa
- Low input capacitance (Ciss)
- · Reduced switching and conduction losses
- Ultra low gate charge (Q_q)
- Avalanche energy rated (UIS)
- · Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

APPLICATIONS

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
 - High-intensity discharge (HID)
 - Fluorescent ballast lighting
- Industrial
 - Welding
 - Induction heating
 - Motor drives
 - Battery chargers
 - Renewable energy
 - Solar (PV inverters)

ORDERING INFORMATION	
Package	TO-220AB
Lead (Pb)-free and halogen-free	SiHP22N60EF-GE3

ABSOLUTE MAXIMUM RATINGS (T _C	= 25 °C, unl	less otherwis	se noted)			
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-source voltage			V _{DS}	600	V	
Gate-source voltage	V _{GS}	± 30	V			
Continuous drain surrant $(T_{1} - 150 ^{\circ}\text{C})$	V _{GS} at 10 V	$T_{\rm C} = 25 \ ^{\circ}{\rm C}$ $T_{\rm C} = 100 \ ^{\circ}{\rm C}$		19		
Continuous drain current ($T_J = 150 \ ^{\circ}C$)	VGS at 10 V	T _C = 100 °C	I _D	12	А	
Pulsed drain current ^a			I _{DM}	46		
Linear derating factor				1.4	W/°C	
Single pulse avalanche energy ^b			E _{AS}	144	mJ	
Maximum power dissipation			PD	179	W	
Operating junction and storage temperature range			T _J , T _{stg}	-55 to +150	°C	
Drain-source voltage slope $T_J = 125 \text{ °C}$			alı . / alt	70		
Reverse diode dv/dt ^d			dv/dt	50	V/ns	
Soldering recommendations (peak temperature) ^c	For	10 s		260	°C	

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature

b. V_{DD} = 140 V, starting T_J = 25 °C, L = 28.2 mH, R_q = 25 Ω , I_{AS} = 3.2 A

c. 1.6 mm from case

d. $I_{SD} \leq I_D, \, di/dt = 400$ A/µs, starting $T_J = 25 \ ^\circ C$

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1 For technical questions, contact: hvm@vishay.com



THERMAL RESISTANCE RA	TINGS						
PARAMETER	SYMBOL	TYP.	MAX.			UNIT	
Maximum junction-to-ambient	R _{thJA}	-	62			°C/W	
Maximum junction-to-case (drain)	R _{thJC}	-	0.7			C/ W	
SPECIFICATIONS (T _J = 25 °C	unless otherwi	se noted)					
PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static	•	·			•	•	

Static							
Drain-source breakdown voltage	V _{DS}	V _{GS} =	= 0 V, I _D = 250 μA	600	-	-	V
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	Reference to 25 °C, $I_D = 1 \text{ mA}$		-	0.68	-	V/°C
Gate-source threshold voltage (N)	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$		2.0	-	4.0	V
			V _{GS} = ± 20 V	-	-	± 100	nA
Gate-source leakage	I _{GSS}		V _{GS} = ± 30 V	-	-	± 1	μA
		V _{DS} =	= 480 V, V _{GS} = 0 V	-	-	1	
Zero gate voltage drain current	I _{DSS}	V _{DS} = 480 V	/, V _{GS} = 0 V, T _J = 125 °C	-	-	500	μA
Drain-source on-state resistance	R _{DS(on)}	$V_{GS} = 10 V$	I _D = 11 A	-	0.158	0.182	Ω
Forward transconductance ^a	9 _{fs}	V _{DS}	= 30 V, I _D = 11 A	-	5.8	-	S
Dynamic					•		
Input capacitance	C _{iss}		$V_{GS} = 0 V$,	-	1423	-	
Output capacitance	C _{oss}	1	$V_{DS} = 100 V,$	-	73	-	1
Reverse transfer capacitance	C _{rss}	1	f = 1 MHz	-	5	-	1
Effective output capacitance, energy related ^a	C _{o(er)}	– V _{DS} = 0 V to 480 V, V _{GS} = 0 V		-	48	-	pF
Effective output capacitance, time related ^b	C _{o(tr)}			-	240	-	
Total gate charge	Qg			-	48	96	
Gate-source charge	Q _{gs}	$V_{GS} = 10 V$	I _D = 11 A, V _{DS} = 480 V	-	9	-	nC
Gate-drain charge	Q _{gd}			-	21	-	
Turn-on delay time	t _{d(on)}			-	15	30	
Rise time	t _r	– V _{DD} = 480 V, I _D = 11 A,		-	21	42	1
Turn-off delay time	t _{d(off)}	V _{GS} =	= 10 V, R _g = 9.1 Ω	-	58	87	ns
Fall time	t _f			-	25	50	
Gate input resistance	R _g	f = 1 MHz, open drain		0.3	0.6	1.2	Ω
Drain-Source Body Diode Characteristic	s				•		
Continuous source-drain diode current	I _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	19	
Pulsed diode forward current	I _{SM}			-	-	46	- A
Diode forward voltage	V _{SD}	T _J = 25 °C	C, I _S = 11 A, V _{GS} = 0 V	-	-	1.2	V
Reverse recovery time	t _{rr}			-	113	226	ns
Reverse recovery charge	Q _{rr}		5 °C, $I_F = I_S = 11 \text{ A}$,	-	0.7	1.4	μC
Reverse recovery current	I _{RRM}	ai/at = 1	100 A/µs, V _R = 400 V	-	11	-	A

Notes

a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} b. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS}



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

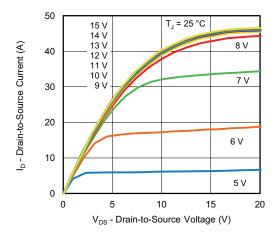


Fig. 1 - Typical Output Characteristics

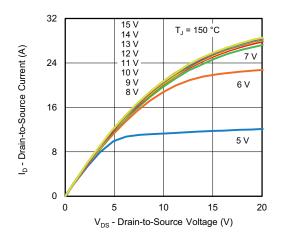


Fig. 2 - Typical Output Characteristics

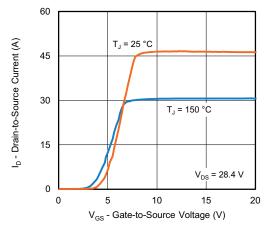


Fig. 3 - Typical Transfer Characteristics

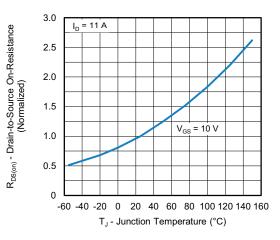


Fig. 4 - Normalized On-Resistance vs. Temperature

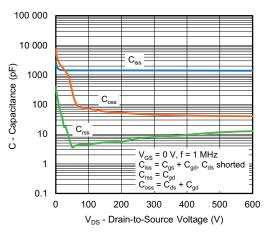


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

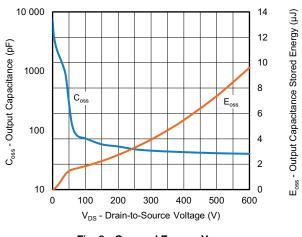


Fig. 6 - $C_{\rm oss}$ and $E_{\rm oss}$ vs. $V_{\rm DS}$

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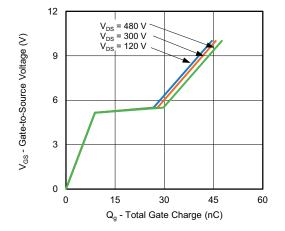


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

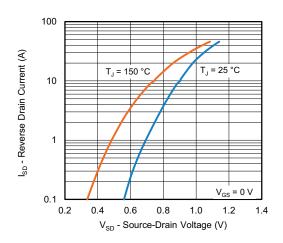
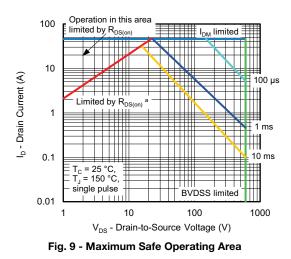
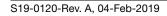


Fig. 8 - Typical Source-Drain Diode Forward Voltage



Note

a. V_{GS} > minimum V_{GS} at which $R_{DS(on)}$ is specified



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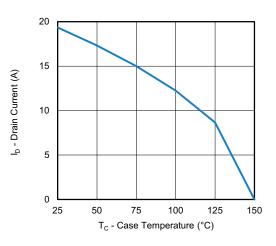


Fig. 10 - Maximum Drain Current vs. Case Temperature

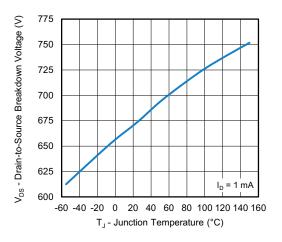


Fig. 11 - Temperature vs. Drain-to-Source Voltage

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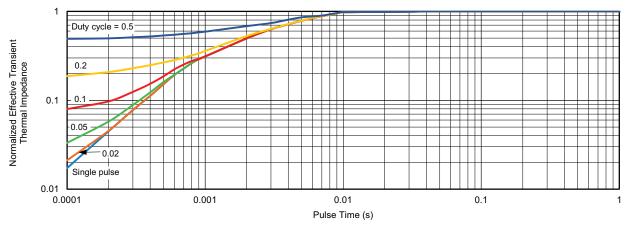


Fig. 12 - Normalized Transient Thermal Impedance, Junction-to-Case

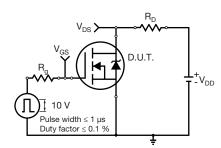


Fig. 13 - Switching Time Test Circuit

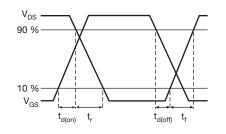


Fig. 14 - Switching Time Waveforms

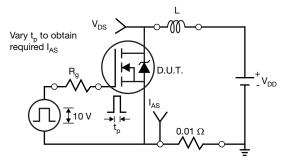


Fig. 15 - Unclamped Inductive Test Circuit

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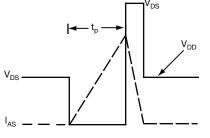


Fig. 16 - Unclamped Inductive Waveforms

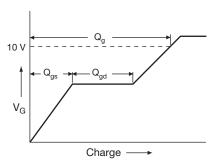
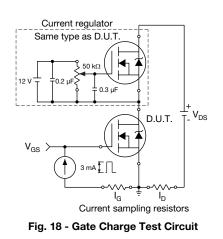
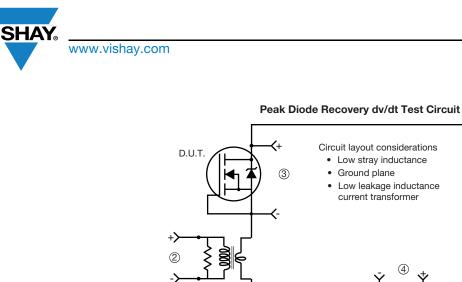


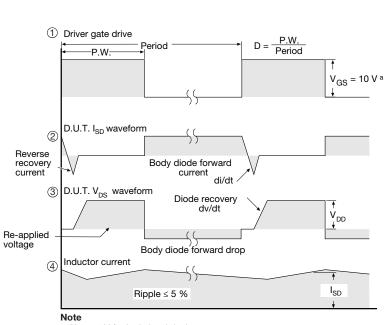
Fig. 17 - Basic Gate Charge Waveform



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dv/dt controlled by R_g
Driver same type as D.U.T.

I_{SD} controlled by duty factor "D"
D.U.T. - device under test

a. $V_{GS} = 5$ V for logic level devices

Fig. 19 - For N-Channel

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V_{DD}



TO-220-1



DIM	MILLIN	IETERS	INC	HES	
DIM.	MIN.	MAX.	MIN.	MAX.	
А	4.24	4.65	0.167	0.183	
b	0.69	1.02	0.027	0.040	
b(1)	1.14	1.78	0.045	0.070	
С	0.36	0.61	0.014	0.024	
D	14.33	15.85	0.564	0.624	
E	9.96	10.52	0.392	0.414	
е	2.41	2.67	0.095	0.105	
e(1)	4.88	5.28	0.192	0.208	
F	1.14	1.40	0.045	0.055	
H(1)	6.10	6.71	0.240	0.264	
J(1)	2.41	2.92	0.095	0.115	
L	13.36	14.40	0.526	0.567	
L(1)	3.33	4.04	0.131	0.159	
ØP	3.53	3.94	0.139	0.155	
Q	2.54	3.00	0.100	0.118	

Note

• M* = 0.052 inches to 0.064 inches (dimension including protrusion), heatsink hole for HVM



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